



SURFACE MOUNT LOW LEAKAGE DIODE

BAS116

Features

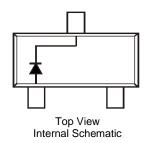
- Surface Mount Package Ideally Suited for Automated Insertion
- Very-Low Leakage Current
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead-Free Plating). Solderable per MIL-STD-202, Method 208 @3
- Polarity: See Diagram
- Weight: 0.008 grams (Approximate)







Ordering Information (Note 4)

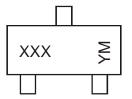
Pa	rt Number	Qualification	Case	Packaging		
B	AS116-7-F	Commercial	SOT23	3000/Tape & Reel		
BA	S116-13-F	Commercial	SOT23	10,000/Tape & Reel		
BA	S116Q-7-F	Automotive	SOT23	3000/Tape & Reel		
BA	S116Q-13-F	Automotive	SOT23	10,000/Tape & Reel		
Notes: 1. No p	Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.					

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds

4. For packaging details, go to our website at http://www.diodes.com.

Marking Information



XXX = Product Type Marking Code; K50 YM = Date Code Marking Y = Year (ex: G = 2019)M = Month (ex: 9 = September)

Date Code Kev

Year	2001	2002		2018	2019	2020	2021	2022	2023	2024	2025	2026
Code	М	N		F	G	Н		J	К	L	М	Ν
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@T_A = 25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	85	V
RMS Reverse Voltage		V _{R(RMS)}	60	V
Forward Continuous Current (Note 5)		I _{FM}	215	mA
Repetitive Peak Forward Current		I _{FRM}	500	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0µs @ t = 1.0ms @ t = 1.0s	I _{FSM}	4.0 1.0 0.5	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5) $@T_A = 25^{\circ}C$	PD	250	mW
Thermal Resistance Junction to Ambient Air (Note 5) @T _A = 25°C	R _{OJA}	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

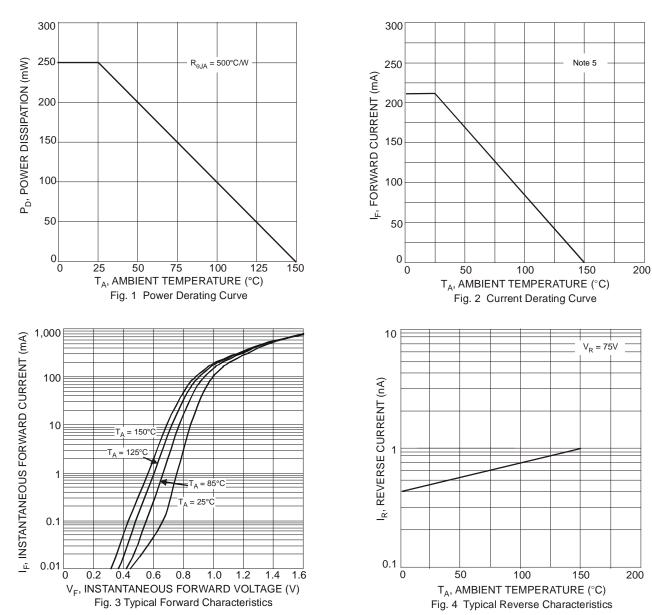
Electrical Characteristics (@T_A = 25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V _{(BR)R}	85			V	I _R = 100μA
Forward Voltage	VF	_		0.90 1.0 1.1 1.25	V	$I_{F} = 1.0mA$ $I_{F} = 10mA$ $I_{F} = 50mA$ $I_{F} = 150mA$
Leakage Current (Note 6)	I _R		_	5.0 80	nA nA	V _R = 75V V _R = 75V, T _i = 150°C
Total Capacitance	Ст	_	2		pF	V _R = 0, f = 1.0MHz
Reverse Recovery Time	t _{rr}		_	3.0	μs	$I_{F} = I_{R} = 10 \text{mA},$ $I_{rr} = 0.1 \times I_{R}, R_{L} = 100 \Omega$

Notes:

5. Part mounted on FR-4, 2oz 1inch squared copper pad PC board.
 6. Short duration pulse test used to minimize self-heating effect.



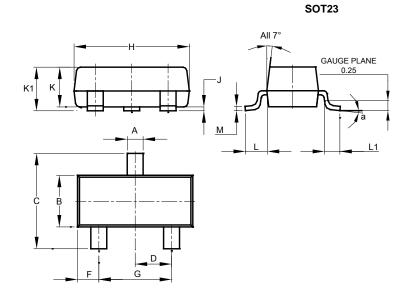




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Package Outline Dimensions

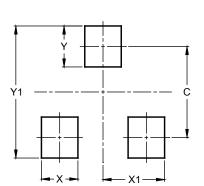
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23							
Dim	Min	Max	Тур				
Α	0.37	0.51	0.40				
В	1.20	1.40	1.30				
С	2.30	2.50	2.40				
D	0.89	1.03	0.915				
F	0.45	0.60	0.535				
G	1.78	2.05	1.83				
Н	2.80	3.00	2.90				
J	0.013	0.10	0.05				
К	0.890	1.00	0.975				
K1	0.903	1.10	1.025				
L	0.45	0.61	0.55				
L1	0.25	0.55	0.40				
М	0.085	0.150	0.110				
а	0°	8°					
All	All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23

Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9



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